# Hitachi High-Tech

HITACHI

# **FY11 2nd Quarter Financial Results**

October 25, 2011

**@**Hitachi High-Technologies Corporation

Vice President and Executive Officer Morihiro Nishida

Copyright@2011 Hitachi High-Technologies Corporation All Rights Reserved.

Notes are from p.6 onward.

# **Contents**



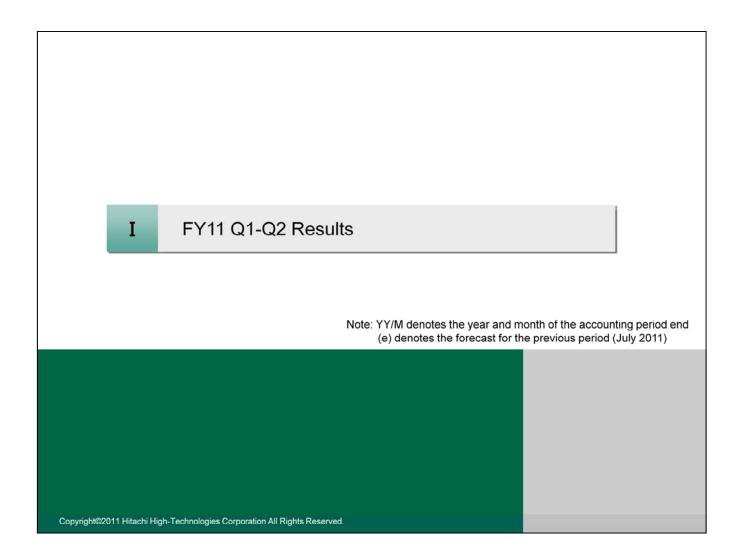
# FY11 2nd Quarter Financial Results

I FY11 Q1-Q2 Results

II FY11 Outlook

**Ⅲ** Data

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.



# FY11 Q1-Q2 (Highlights)

Hitachi High-Tech HITACHI

(100 million yen)

	Results	YoY		vs. Previous I	orecast
	results	Increase / Decrease	Ratio	Increase / Decrease	Ratio
Sales	3,216	-137	-4%	+116	+4%
Operating Income	123	-15	-11%	+43	+53%
Ordinary Income	125	-18	-13%	+45	+56%
Net Income	79	-19	-19%	+29	+58%
Net Income per Share	<b>57.38</b> yen	- 13.73yen		+2	1.03yen
Cash Dividend per Share*	20.00yen	+10.00yen		+10.00	
FCF	+99	+13			Δ5

\*Includes memorial dividend of 10yen (in commemoration of 10 years of operation)

(Note)Previous forecast, published July 2011

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.

# FY11 Q1-Q2 (Explanation of Deviations)



vs. Previous Forecast (July 2011)

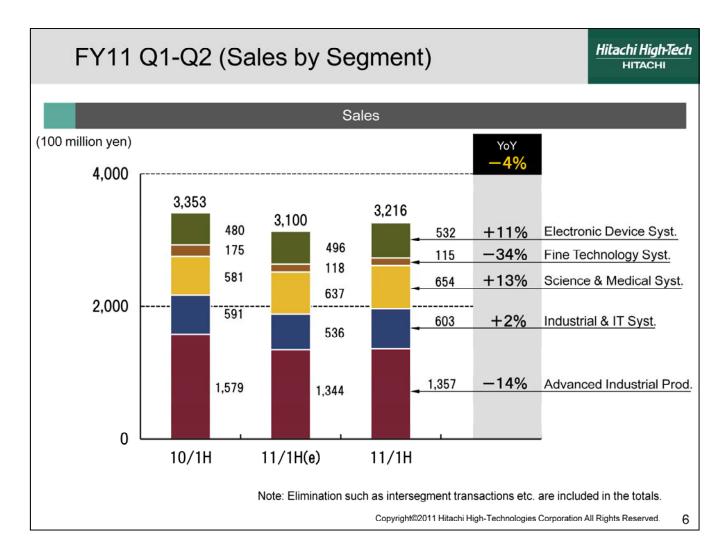
## Sales (310.0Ybn $\rightarrow$ 321.6Ybn +11.6Ybn )

- Electronic Device Systems: Robust sales of process and metrology equipments for the U.S. and European market led to 3.6Ybn increase.
- Science & Medical Systems: Accelerated delivery of new DNA sequencers led to 1.8Ybn increase.
- Industrial & IT Systems: Accelerated delivery of new mobile phones for the U.S. market led to 6.6Ybn increase.
- Advanced Industrial Products: Accelerated delivery of automobile components due to recovery of the Great East Japan Earthquake led to 1.3Ybn increase.

## Operating Income (8.0Ybn → 12.3Ybn +4.3Ybn)

- Electronic Device Systems: Similar reasons as the sales led to 1.1Ybn increase.
- Science & Medical Systems: Similar reasons as the sales plus improved production operation of Naka Area from the Great East Japan Earthquake led to 2.9Ybn increase.

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.



### ■ Explanation of YoY Variations

· Electronic Device Systems

Decrease in back-end & assembly equipments due to delay in capex caused by the sluggish memory market. However, robust sales of process equipment based on miniaturization will lead to YoY 11% increase.

### ·Fine Technologies Systems

Delay of capex for FPD manufacturing equipment caused by price down of TV panels and decline in HD manufacturing equipment capex will lead to YoY 34% decrease.

#### Science & Medical Systems

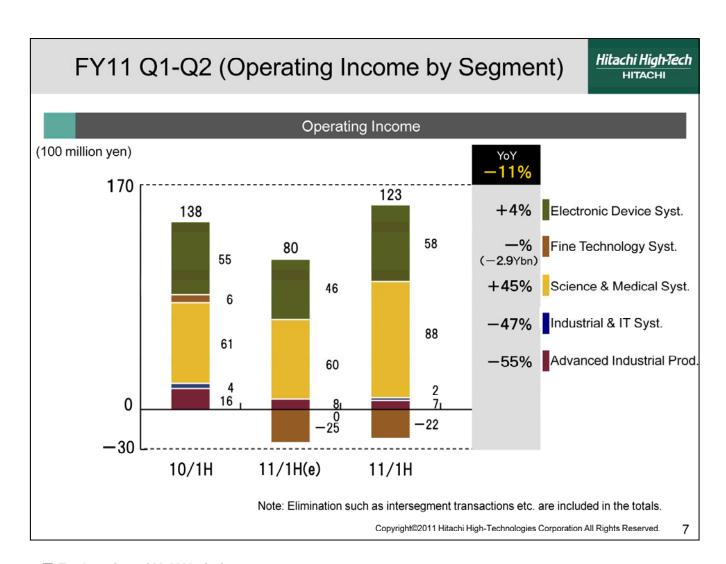
Accelerated delivery which was delayed from FY10 due to earthquake and medical /biotechnology-related new products will lead to YoY 13% increase.

#### Industrial & IT Systems

Customers' production decrease caused by the earthquake can be seen, but good start of new mobile phones for the U.S. market will lead to YoY 2% increase.

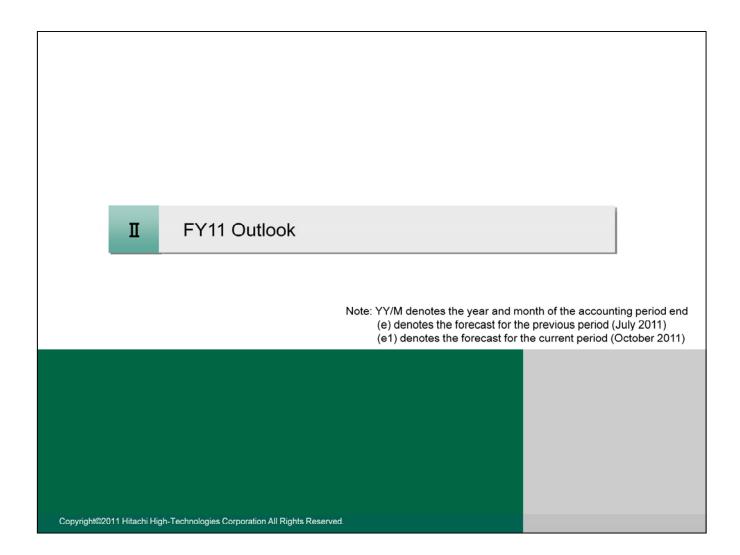
#### · Advanced Industrial Products

Sluggish demands for industrial and electronic materials due to earthquake lead to YoY 14% decrease.



## **■** Explanation of YoY Variations

Similar reasons as the sales can be applied for the operating income.



# FY11 Outlook (Highlights)



(100 million yen)

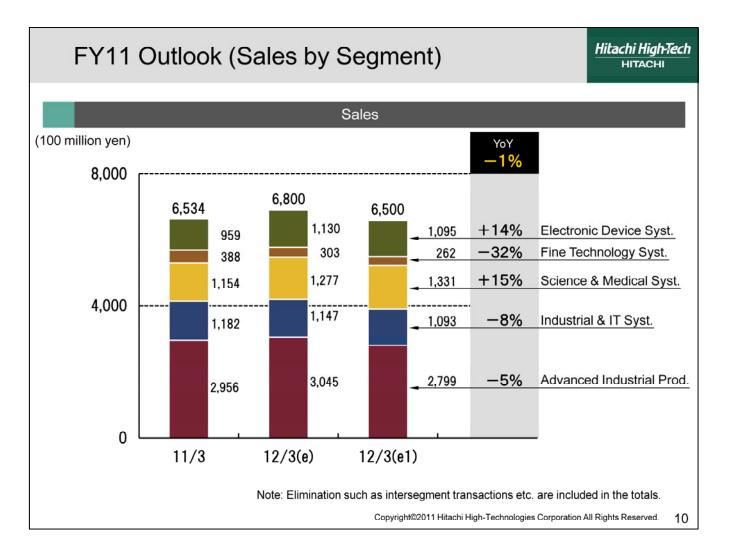
	FY11 Outlook	YoY		vs. Previous F	orecast
	1 1 11 Outlook	Increase / Decrease	Ratio	Increase / Decrease	Ratio
Sales	6,500	-34	-1%	-300	-4%
Operating Income	280	+1	+0%	±0	±0%
Ordinary Income	280	-15	-5%	±0	±0%
Net Income	180	+2	+1%	±0	±0%
Net Income per Share	130.87yen	1.80yen		±00.00yer	
Cash Dividend per Share*	30.00yen	+10.00yen		+10.00ye	
ROE	7.2%	-0.3%		±09	
FIV	+44	Δ15		5	
FCF	+150	△71			±0

<sup>\*</sup>Includes memorial dividend of 10yen (in commemoration of 10 years of operation)

(Note)Previous forecast, published June 2011

FX rate estimate: 1USD= 80yen, 1EUR= 110yen

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.

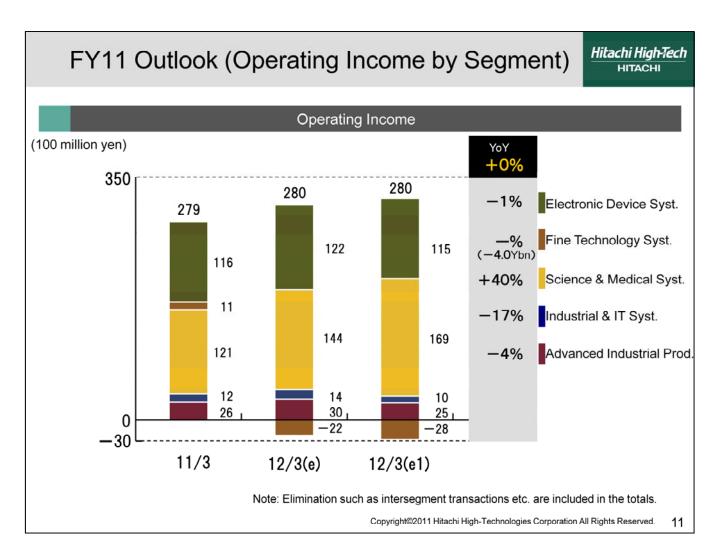


### **■** Explanation of YoY Variations

- Electronic Device Systems
  Growth in process equipment for U.S. customer leads to YoY 14% increase.
- •Fine Technologies Systems

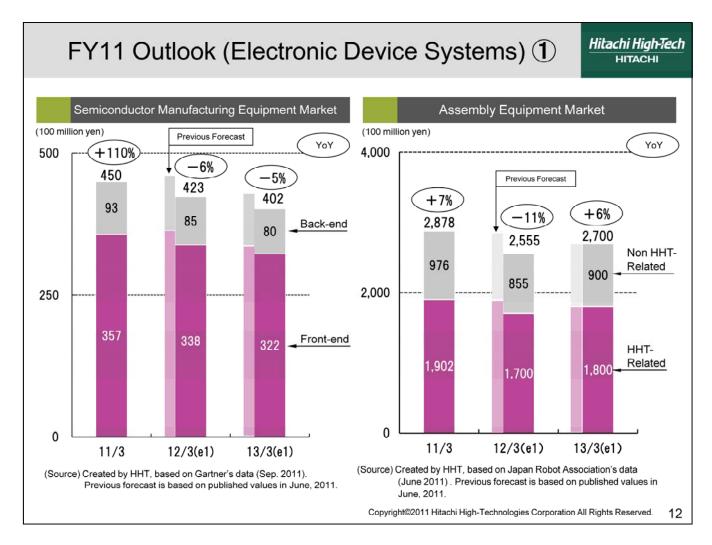
  Delay of capex for FPD manufacturing equipment caused by price down of TV panels and decline in

  HD manufacturing equipment capex lead to YoY 32% decrease.
- •Science & Medical Systems
  Investment recovery of electron microscopes and analytical instruments in the semiconductor /new energy-related field and new medical/biotechnology-related products lead to YoY 15% increase.
- •Industrial & IT Systems
  Robust sales of mobile phones for the U.S. market triggered by the launch of new models. However, business decline in automotive HDDs due to earthquake lead to YoY 8% decrease.
- Advanced Industrial Products
   Sluggish demands for industrial and electronic materials continue due to earthquake lead to YoY 5% decrease.



#### **■** Explanation of YoY Variations

Similar reasons as the sales can be applied for the operating income.



#### **■** Explanation of Semiconductor Manufacturing Equipment Market

FY11: Positive investments in foundries, MPU and memory manufacturers in Q1. However, due to the overflow of semiconductor inventories, restraints in investments is expected in Q2, leading to YoY 6% decline.

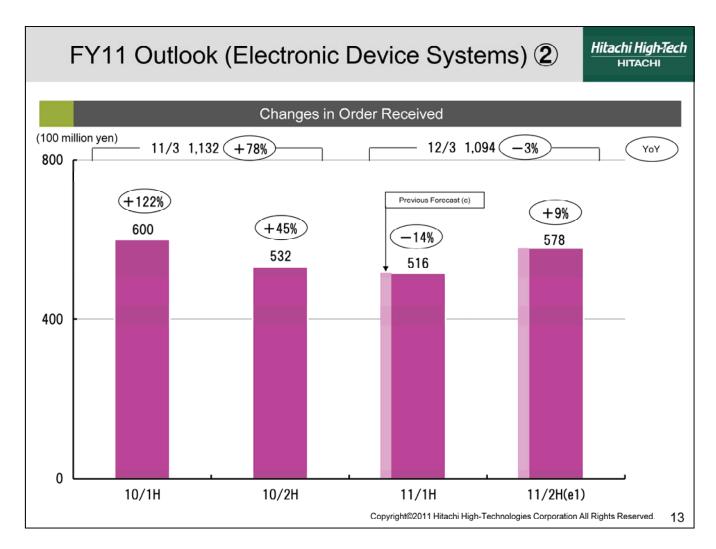
FY12: Positive investments such as foundries will settle down, leading to YoY 5% decline.

#### **■**Explanation of Assembly Equipment Market

FY11: Productions for smartphones and tablet devices increase but investment restraints from EMS, ODM\* which started from Q2 due to sluggish growth in PCs and flat TVs leads to YoY 11% decline.

FY12: In addition to increasing smartphones and tablet devices production, PCs will grow due to the introduction of Ultrabooks, triggering mass investments from major EMS for China etc., leading to YoY 6% growth.

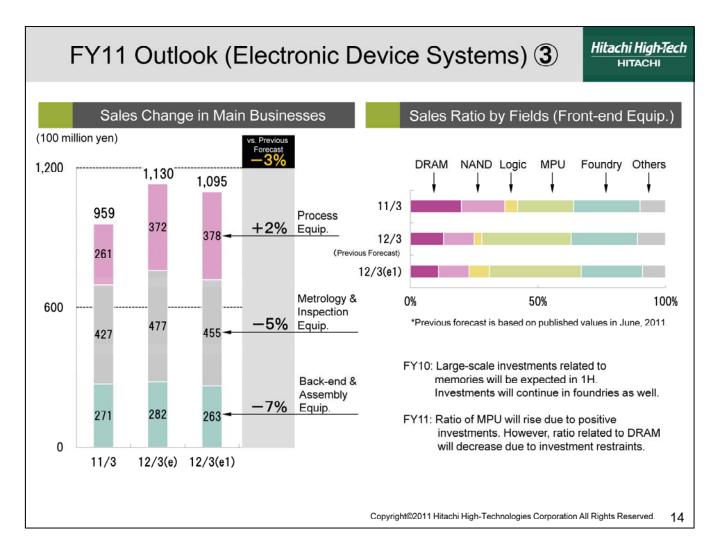
\*Original Design Manufacturing



#### **■**Circumstances of Orders Received

11/1H: Restraints in investment from DRAM-related manufacturers led to YoY 14% decline , QoQ 3% decline

11/2H: The macro economy not being clear, by securing orders coming from the cutting-edge /miniaturization-related investments and mobile device-related investments, lead to YoY 9% increase, QoQ 12% increase.



#### **■**Explanation of Deviations

#### **Process Equipment**

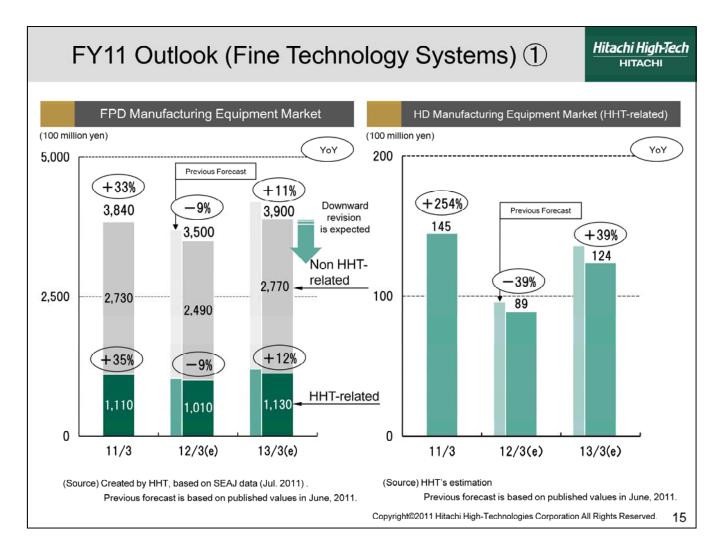
Active investments from main customers and increase in the number of processes applied lead to 2% increase from previous forecast.

#### Metrology & Inspection Equipment

Delays of inspection equipments for memory and wafer manufacturers lead to 5% decline from previous forecast.

#### Back-end & Assembly Equipment

Mobile device-related investments can be expected but due to unclear demands of DRAM and consumer products lead to 7% decline from previous forecast.



#### **■**Explanation of FPD Manufacturing Equipment Market

- FY11: Additional delay is expected in the China investment project from Korea and Taiwan Region due to deterioration of the macro economy.

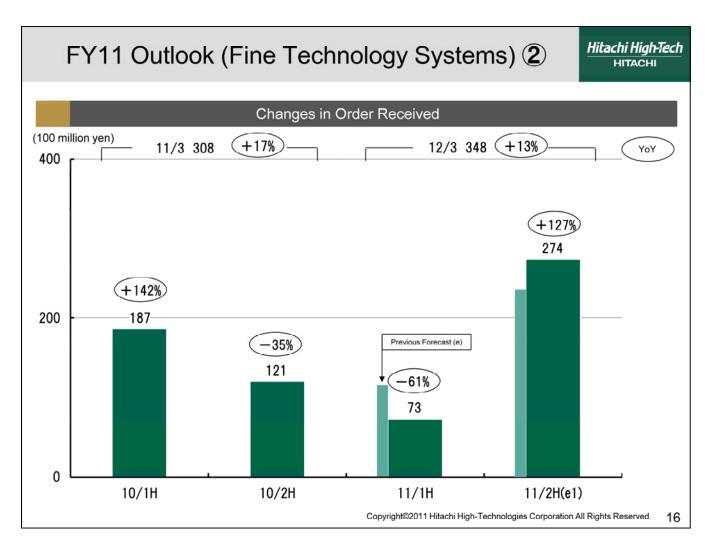
  Investment size and timing is still unclear, leading to YoY 9% decline.
- FY12: Even though investments increase for small/middle size panels, there is the possibility of delay in the China investment project from Korea and Taiwan Region.

  YoY 11% increase is expected based on SEAJ's July 2011 guidance, but negative growth can be expected based on recent situations.

#### **■** Explanation of HD Manufacturing Equipment Market

- FY11: Sluggish macro economy and PC demands triggered HDD's downward revision.

  Mergers and acquisitions among HDD manufacturers will have an effect on mass production investment plans, leading to YoY 39% decline.
- FY12: Delays from disks and glass substrates' mass production investment plans scheduled in FY11 will recover, leading to YoY 39% increase.



#### **■** Circumstances of Orders Received

11/1H: YoY 61% decline, QoQ 39% decline.

### **FPD**

Delays in investment of proximity exposure and module assembly systems for large size panels.

#### <u>HD</u>

Delays in mass production investment plans due to deterioration of the economy and merger and acquisitions among HDD manufacturers.

11/2H: YoY 127% increase, QoQ 275% increase

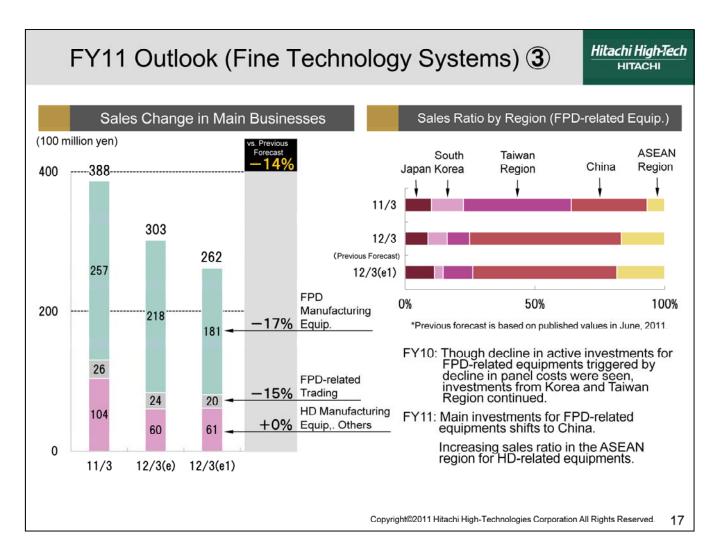
#### <u>FPD</u>

Expect large size panel facilities, small/middle size panels and touch panel investments, mainly in China.

### <u>HD</u>

Expand new concept disk testers and glass substrate inspection systems to mass production lines.

Better relationship with current customers and earn new customers as well for magnetic field shape inspection systems.



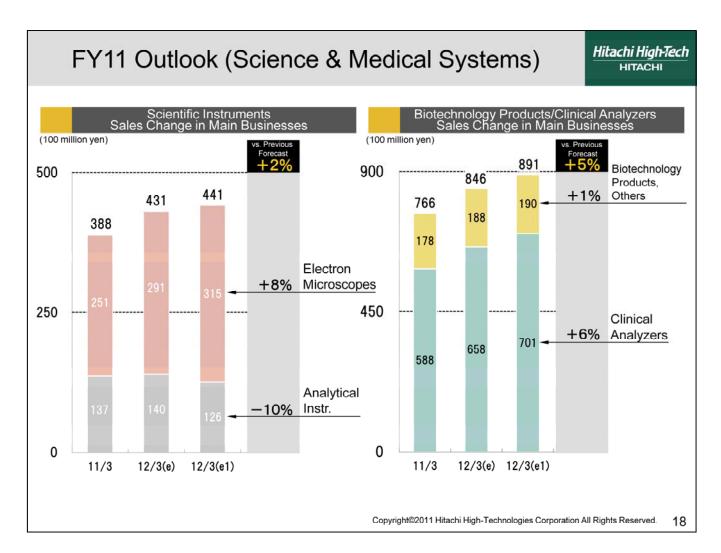
#### ■ Explanation of Deviations

#### **FPD Manufacturing Equipment**

Delay in investment plans of proximity exposure systems for China lead to 17% decline from previous forecast.

#### **HD Manufacturing Equipment, Others**

Sluggish growth in HDD due to decline in PC demands and merger and acquisitions among HDD manufacturers effecting mass production investments lead to no changes from previous forecast.



#### **■**Explanation of Deviations

Even though there were confusion caused by the Great East Japan Earthquake, overall, firm sales are expected.

#### **Scientific Instruments**

#### Electron Microscopes

Effect of new electron microscope leads to YoY 8% increase from previous forecast.

#### Analytical Instruments

Confusion caused by the earthquake and delay of new type liquid chromatograph due to the earthquake lead to YoY 10% decline from previous forecast.

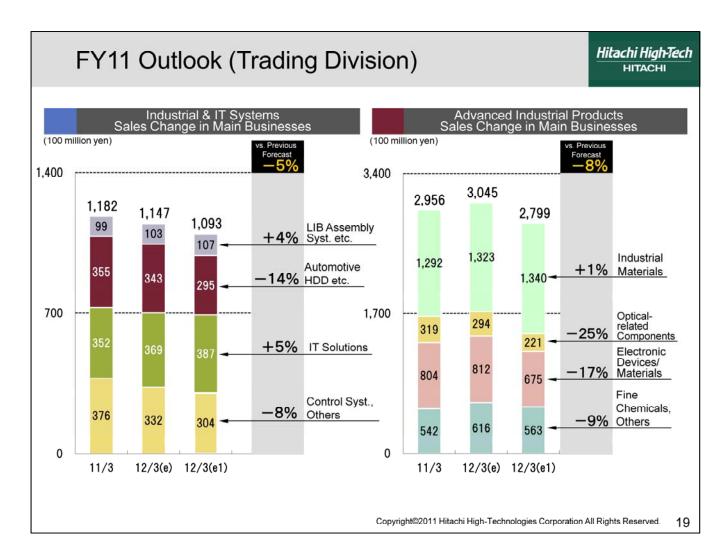
#### **Biotechnology Products/Clinical Analyzers**

#### Biotechnology Products, Others

Launch of new second generation DNA sequencers as planned lead to YoY 1% increase from previous forecast.

#### Clinical Analyzers

Expand sales of new large size blood biochemistry and immunoassay automatic analysis equipment and increased sales in Asia lead to YoY 6% increase from previous forecast.



### ■ Explanation of Deviations

#### **Industrial & IT Systems**

#### LIB Assembly Systems. etc.

Assembly systems for automobile components will face hardships due to the effect of earthquake and decrease in production. However, LIB assembly systems for automobiles and storage is in good shape which lead to YoY 4% increase from previous forecast.

#### Automotive HDD, etc.

Effects to the supply chain triggered by the earthquake caused lack of HDD component supplies which lead to YoY 14% decline from previous forecast.

#### **IT Solutions**

Good start of new mobile phone model for the U.S. market lead to YoY 5% increase from previous forecast.

## Control Systems, Others

Sales slump of FPD manufacturing equipment (trading product) leads to YoY 8% decline from previous forecast.

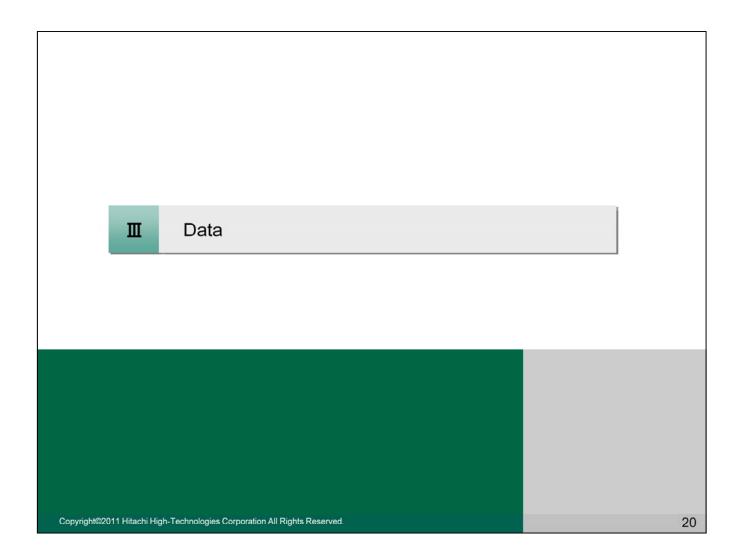
#### **Advanced Industrial Products**

#### Optical-related Components

Inventory adjustments in modules for light transmission equipments and components in emerging countries lead to YoY 25% decrease from previous forecast.

#### **Electronic Devices/Materials**

Moderation of the silicon wafer and FPD-related materials market lead to YoY 17% decline from previous forecast.



# Changes in Quarterly Results

Hitachi High-Tech HITACHI

(100 million yen)

			FY10/Q1	FY10/Q2	FY10/Q3	FY10/Q4	FY11/Q1	FY11/Q2
	Electronic Device Systems	Sales	169	311	193	286	231	301
	Electronic Device Systems	Operating Income	7	48	20	41	24	33
	Fine Technology Systems	Sales	67	108	125	88	36	79
က္က	Time reciniology systems	Operating Income	-1	7	8	-3	-13	-10
Sales	Science & Medical	Sales	275	306	262	311	254	401
_	Systems	Operating Income	30	31	24	36	21	67
per	Industrial & IT Systems	Sales	296	295	262	329	301	302
ating		Operating Income	-3	7	-1	9	-2	4
gln	Advanced Industrial	Sales	802	777	712	666	656	702
Income	Products	Operating Income	11	5	8	2	4	3
<u>ө</u>	Others &	Sales	-24	-29	-26	-26	-25	-21
	Elimination/Corporate	Operating Income	-1	-4	-3	-1	-3	-7
	Total	Sales	1,585	1,768	1,527	1,655	1,452	1,763
	Total	Operating Income	43	95	57	85	32	91
	Ordinary Income		50	93	58	94	36	89
Net Income		35	63	35	44	20	59	

Copyright@2011 Hitachi High-Technologies Corporation All Rights Reserved.

# Capital Expenditures/Depreciation Costs/R&D/Sales by Region



## ■ Capital Expenditures/Depreciation Costs/R&D

(100 million yen)

	1 1 (vec immeriyen							
	10/1H	11/1H	YoY	11/3	12/3 (e1)	YoY		
Capital Expenditure	40	55	+38%	90	185	+106%		
Depreciation Costs	41	42	+3%	90	102	+14%		
R & D	103	114	+10%	208	253	+22%		

(Note) Capital Expenditure is based on an acquisition bases

# ■ Sales by Region

(100 million yen)

		Japan	North America	Europe	Asia	Mainland China	Others	Total
10 /14	Sales	1,475	295	356	1,172	517	55	3,353
10/1H	Ratio	44.0%	8.8%	10.6%	34.9%	15.4%	1.6%	100.0%
11/1H	Sales	1,330	408	406	979	513	93	3,216
	Ratio	41.4%	12.7%	12.6%	30.4%	16.0%	2.9%	100.0%

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.

# Sales Change in Main Business

Hitachi High-Tech HITACHI

(100 million yen)	FY10/Q1	FY10/Q2	FY10/Q3	FY10/Q4	FY11/Q1	FY11/Q2
Electronic Device Systems	169	311	193	286	231	301
Process Equipment	32	77	60	91	92	101
Metrology & Inspection Equipment	79	125	82	142	87	127
Back-end & Assembly Equipment	58	109	51	53	52	72
Fine Technology Systems	67	108	125	88	36	79
FPD Manufacturing Equipment	56	78	103	47	30	66
HD Manufacturing Equipment , Others	11	30	22	41	6	13
Science & Medical Systems	275	306	262	311	254	401
	27	44	31	35	29	38
	36	79	47	89	55	88
	162	139	146	141	108	206
	49	44	38	46	61	67
Industrial & IT Systems	296	295	262	329	301	302
LIB Assembly Systems, etc.	35	21	12	32	13	25
Automotive HDD, etc.	75	82	96	103	87	66
IT Solutions	103	99	66	84	126	130
Control Systems , Others	83	93	88	110	75	80
Advanced Industrial Products	802	777	712	666	656	702
Industrial Materials	336	339	310	307	318	328
Optical-related Components	99	81	71	68	56	57
Electronic Devices /Materials	238	219	192	155	133	171
Fine Chemicals, Others	129	138	138	136	148	145

#### Notes on the data

- 1. All financial statement summaries and results predictions included in this presentation are on a consolidated basis unless otherwise stated. Numerical data is rounded off to the nearest 100 million yen.
- 2. In its disclosures, Hitachi High-Technologies may make statements that constitute forward-looking statements that reflect management's views with respect to certain future events and financial performance at the time of disclosure. Such statements are based on information available at the time of disclosure and may differ from actual results due to various external factors, both direct and indirect. In the event of a major discrepancy with the items disclosed, the Company will disclose on a case-by-case basis based on the law and/or the timely disclosure rules and regulations of the stock exchanges on which the Company is listed.

The information included in this material is for reference when investing, and not a canvass to invest. Brand selection and the final decision is at your own judgment.

Copyright©2011 Hitachi High-Technologies Corporation All Rights Reserved.



# **END**

## **FY11 2nd Quarter Financial Results**

## For further information

Hiroyuki Kato General Manager Corporate Communications Dept. CSR Div.

TEL:+81-3-3504-5138 FAX:+81-3-3504-5943 E-mail:kato-hiroyuki@nst.hitachi-hitec.com

# Hitachi High-Tech

Bringing the frontier to the forefront.

Copyright@2011 Hitachi High-Technologies Corporation All Rights Reserved.